INTEGRATED CIRCUITS

DATA SHEET

74F189A64-bit TTL bipolar RAM, inverting (3-State)

Product specification

1990 Feb 23

IC15 Data Handbook





64-bit TTL bipolar RAM, inverting (3-State)

74F189A

FEATURES

- High speed performance
- Replaces 74F189
- Address access time: 8ns max vs 28ns for 74F189
- Power dissipation: 4.3mW/bit
- Schottky clamp TTL
- One chip enable
- Inverting outputs (for non-inverting outputs see 74F219A)
- 3-State outputs
- 74F189A in 150 mil wide SO is preferred options for new designs

are fully decoded on chip. The outputs are in high impedance state whenever the chip enable (\overline{CE}) is high. The outputs are active only in the READ mode $(\overline{WE} = \text{high})$ and the output data is the complement of the stored data.

TYPE	TYPICAL ACCESS TIME	TYPICAL SUPPLY CURRENT (TOTAL)
74F189A	5.0ns	55mA

DESCRIPTION

The 74F189A is a high speed, 64-bit RAM organized as a 16-word by 4-bit array. Address inputs are buffered to minimize loading and

ORDERING INFORMATION

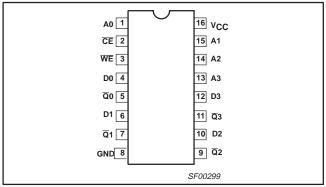
	ORDER CODE			
DESCRIPTION	COMMERCIAL RANGE V_{CC} = 5V \pm 10%, T_{amb} = 0°C to +70°C	DRAWING NUMBER		
16-pin plastic Dual In-line Package	N74F189AN	SOT38-4		
16-pin plastic Small Outline (150mil)	N74F189AD	SOT109-1		

INPUT AND OUTPUT LOADING AND FAN OUT TABLE

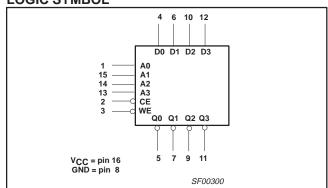
PINS	DESCRIPTION	74F (U.L.) HIGH/LOW	LOAD VALUE HIGH/LOW		
D0 – D3	Data inputs	1.0/1.0	20μA/0.6mA		
A0 – A3	Address inputs	1.0/1.0	20μA/0.6mA		
CE	Chip enable input (active low)	1.0/2.0	20μA/1.2mA		
WE	Write enable input (active low)	1.0/2.0	20μA/1.2mA		
$\overline{\mathbb{Q}}0 - \overline{\mathbb{Q}}3$	Data outputs	150/40	3mA/24mA		

NOTE: One (1.0) FAST unit load is defined as: $20\mu A$ in the high state and 0.6mA in the low state.

PIN CONFIGURATION



LOGIC SYMBOL

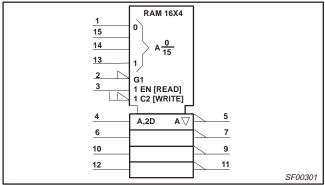


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IEC/IEEE SYMBOL



FUNCTION TABLE

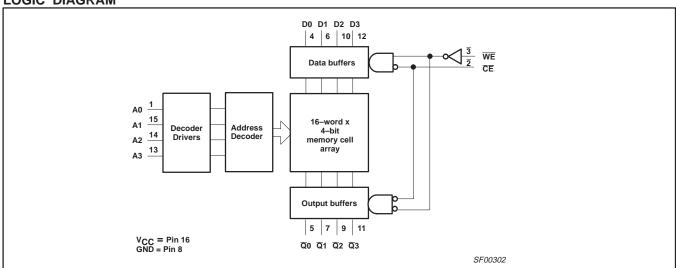
П	NPUTS	3	OUTPUT	OPERATING
CE	WE	Dn	\overline{Q}_n	MODE
L	Н	Х	Complement of stored data	Read
L	L	L	High impedance	Write "0"
Н	L	Н	High impedance	Write "1"
Н	Х	Х	High impedance	Disable input

NOTES:

H = High voltage level L = Low voltage level

X = Don't care

LOGIC DIAGRAM



ABSOLUTE MAXIMUM RATINGS

(Operation beyond the limit set forth in this table may impair the useful life of the device. Unless otherwise noted these limits are over the operating free air temperature range.)

SYMBOL	PARAMETER	RATING	UNIT
V _{CC}	Supply voltage	-0.5 to +7.0	V
V _{IN}	Input voltage	-0.5 to +7.0	V
I _{IN}	Input current	-30 to +5	mA
V _{OUT}	Voltage applied to output in high output state	–0.5 to V _{CC}	V
lout	Current applied to output in low output state	48	mA
T _{amb}	Operating free air temperature range	0 to +70	°C
T _{stg}	Storage temperature range	-65 to +150	°C

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RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER		LIMITS	UNIT	
STWIBUL	PARAMETER	MIN	NOM	MAX	$T_A = -40 \text{ to } +85^{\circ}\text{C}$
V _{CC}	Supply voltage	4.5	5.0	5.5	V
V _{IH}	High-level input voltage	2.0			V
V _{IL}	Low-level input voltage			0.8	V
I _{lk}	Input clamp current			-18	mA
Іон	High-level output current			-3	mA
I _{OL}	Low-level output current			24	mA
T _{amb}	Operating free air temperature range	0		+70	°C

DC ELECTRICAL CHARACTERISTICS

(Over recommended operating free-air temperature range unless otherwise noted.)

SYMBOL	PARAMETER		TEST CONDITIONS		LIMITS			
				MIN	TYP ²	MAX		
V _{OH}	High-level output voltage		V _{CC} = MIN, V _{IL} = MAX	±10%V _{CC}	2.4			V
			$V_{IH} = MIN, I_{OH} = MAX$	±5%V _{CC}	2.7	3.4		V
V _{OL}	OL Low-level output voltage		V _{CC} = MIN, V _{IL} = MAX	±10%V _{CC}		0.35	0.50	V
			V _{IH} = MIN, I _{OL} = MAX	±5%V _{CC}		0.35	0.50	V
V _{IK}	Input clamp voltage		$V_{CC} = MIN, I_I = I_{IK}$			-0.73	-1.2	V
ΙĮ	Input current at maximum input	voltage	$V_{CC} = MAX, V_I = 7.0V$			100	μΑ	
I _{IH}	High-level input current		$V_{CC} = MAX, V_I = 2.7V$			20	μΑ	
I _{IL}	Low-level input current	others	$V_{CC} = MAX, V_I = 0.5V$			-0.6	mA	
		CE, WE					-1.2	mA
I _{OZH}	Offset output current, high-level voltage applied		$V_{CC} = MAX, V_I = 2.7V$				50	μА
I _{OZL}	Offset output current, low–level voltage applied		$V_{CC} = MAX, V_I = 0.5V$				- 50	μА
Ios	Short-circuit output current ³		$V_{CC} = MAX$		-60		-150	mA
I _{CC}	Supply current (total)		$V_{CC} = MAX, \overline{CE} = \overline{WE} = GND$			55	80	mA
C _{IN}	Input capacitance		$V_{CC} = 5V, V_{IN} = 2.0V$			4		pF
C _{OUT}	Output capacitance		$V_{CC} = 5V, V_{OUT} = 2.0V$			7		pF

NOTES:

- For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.
 All typical values are at V_{CC} = 5V, T_{amb} = 25°C.

Not more than one output should be shorted at a time. For testing los, the use of high-speed test apparatus and/or sample-and-hold techniques are preferable in order to minimize internal heating and more accurately reflect operational values. Otherwise, prolonged shorting of a high output may raise the chip temperature well above normal and thereby cause invalid readings in other parameter tests. In any sequence of parameter tests, I_{OS} tests should be performed last.

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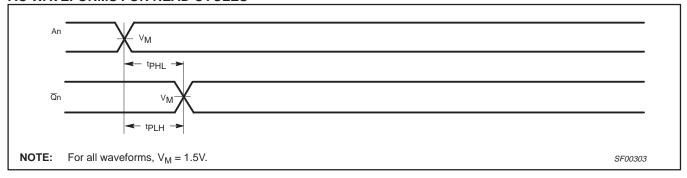
AC ELECTRICAL CHARACTERISTICS

						LIM	ITS		
				Ta	_{mb} = +25	°C	$T_{amb} = 0^{\circ}C$	i i	
SYMBOL	PARA	TEST	V,	_{CC} = +5.0	V	V _{CC} = +5.	UNIT		
		CONDITION	C _L = 5	0pF, R _L =	500 Ω	C _L = 50pF,			
				MIN	TYP	MAX	MIN	MAX	1 1
t _{PLH} t _{PHL}	Access time	Propagation delay An to Qn	Waveform 1	2.5 2.0	5.0 4.5	8.0 8.0	2.5 2.0	8.0 8.0	ns
t _{PZH} t _{PZL}		Enable time CE to Qn	Waveform 2	2.0 2.0	3.5 4.0	6.0 7.0	1.5 2.0	7.0 7.5	ns
t _{PHZ} t _{PLZ}	Disable time CE to Qn		Waveform 3	2.5 1.5	4.5 3.0	7.0 5.5	2.0 1.5	8.0 6.0	ns
t _{PZH} t _{PZL}	Write recovery time	Enable time WE to Qn	Waveform 4	2.0 2.5	4.0 4.5	6.5 7.5	2.0 2.5	7.0 8.0	ns
t _{PHZ}	Disable time WE to Qn	Waveform 4	3.5 1.5	5.5 3.5	8.5 6.5	3.0 1.5	9.0 7.0	ns	

AC SETUP REQUIREMENT

			LIMITS						
SYMBOL	PARAMETER	TEST		_{mb} = +25 _{CC} = +5.0		$T_{amb} = 0^{\circ}C$ $V_{CC} = +5.$	UNIT		
		CONDITION	C _L = 50	0pF, R _L =	500 Ω	$C_L = 50pF$	$R_L = 500\Omega$	1 1	
			MIN	TYP	MAX	MIN	MAX		
t _{su} (H) t _{su} (L)	Setup time, high or low An to WE	Waveform 4	4.5 4.5			5.0 5.0		ns	
t _h (H) t _h (L)	Hold time, high or low An to $\overline{\text{WE}}$	Waveform 4	0			0		ns	
t _{su} (H) t _{su} (L)	Setup time, high or low Dn to $\overline{\text{WE}}$	Waveform 4	7.5 6.5			9.0 8.0		ns	
t _h (H) t _h (L)	Hold time, high or low Dn to $\overline{\text{WE}}$	Waveform 4	0 0			0 0		ns	
t _{su} (L)	Setup time, low $\overline{\text{CE}}$ (falling edge) to $\overline{\text{WE}}$ (falling edge)	Waveform 4	0			0		ns	
t _h (L)	Hold time, low \overline{WE} (falling edge) to \overline{WE} (rising edge)	Waveform 4	6.5			7.5		ns	
t _w (L)	Pulse width, low WE	Waveform 4	7.0			8.0		ns	

AC WAVEFORMS FOR READ CYCLES



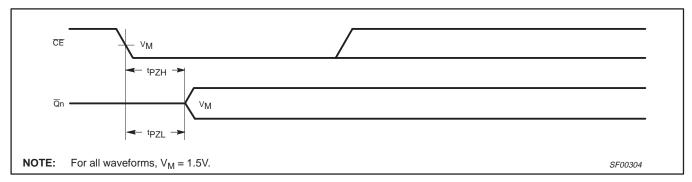
Waveform 1. Read cycle, address access time

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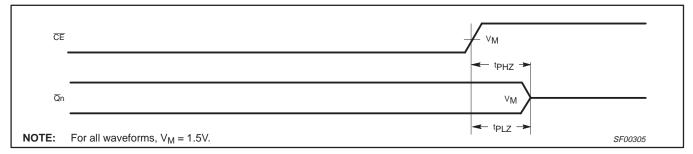
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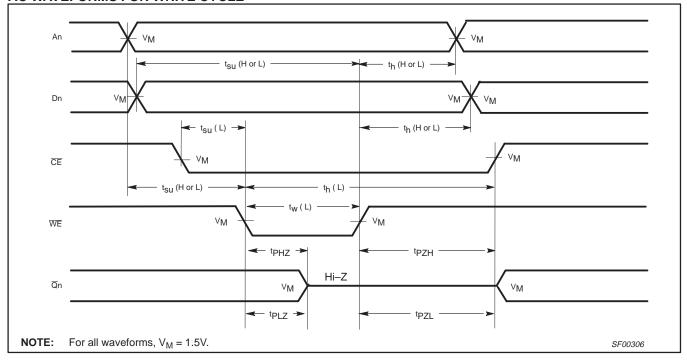


Waveform 2. Read cycle, chip enable access time



Waveform 3. Read cycle, chip disable time

AC WAVEFORMS FOR WRITE CYCLE



Waveform 4. Write cycle

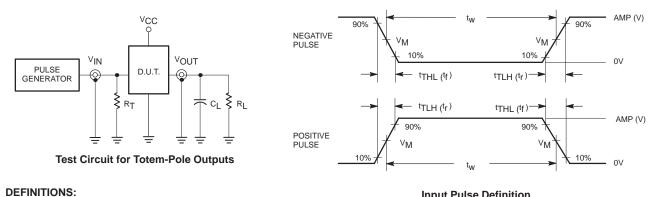
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TEST CIRCUIT AND WAVEFORM



R_L = Load resistor;

see AC ELECTRICAL CHARACTERISTICS for value. Load capacitance includes jig and probe capacitance; see AC ELECTRICAL CHARACTERISTICS for value.

Termination resistance should be equal to Z_{OUT} of pulse generators.

Input Pulse Definition	1
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family	INP	INPUT PULSE REQUIREMENTS										
family	amplitude	V_{M}	V _M rep. rate		t _{TLH}	t _{THL}						
74F	3.0V	1.5V	1MHz	500ns	2.5ns	2.5ns						

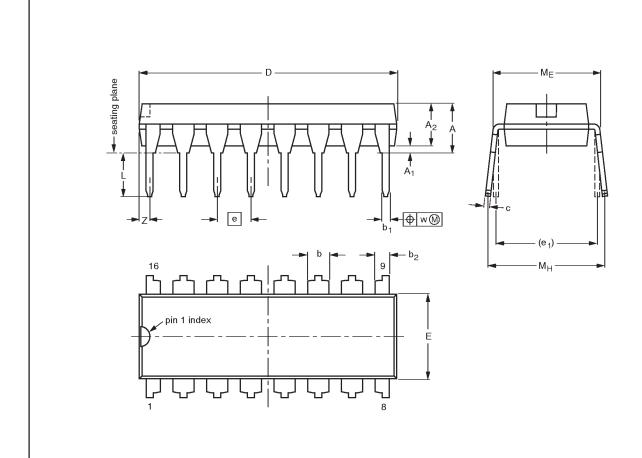
SF00006

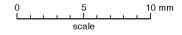
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DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4





DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	b ₂	С	D ⁽¹⁾	E ⁽¹⁾	е	e ₁	L	ME	Мн	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.030

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT38-4						92-11-17 95-01-14

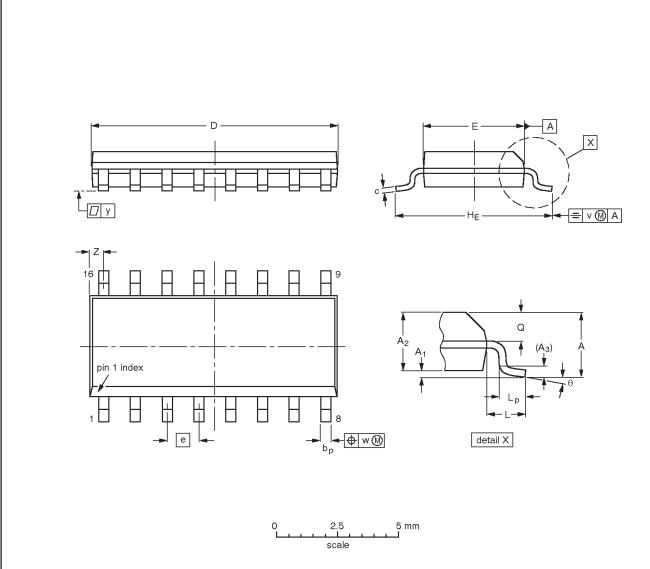
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SO16: plastic small outline package; 16 leads; body width 3.9 mm

SOT109-1



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	bp	С	D ⁽¹⁾	E ⁽¹⁾	е	HE	L	Lp	Q	v	w	у	Z ⁽¹⁾	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8°
inches	0.069	0.010 0.004	0.057 0.049	0.01		0.0100 0.0075	0.39 0.38	0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016		0.01	0.01	0.004	0.028 0.012	0°

Note

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	1330E DATE
SOT109-1	076E07S	MS-012AC				95-01-23 97-05-22

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Data sheet status

Data sheet status	Product status	Definition [1]
Objective specification	Development	This data sheet contains the design target or goal specifications for product development. Specification may change in any manner without notice.
Preliminary specification	Qualification	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make chages at any time without notice in order to improve design and supply the best possible product.
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^[1] Please consult the most recently issued datasheet before initiating or completing a design.

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